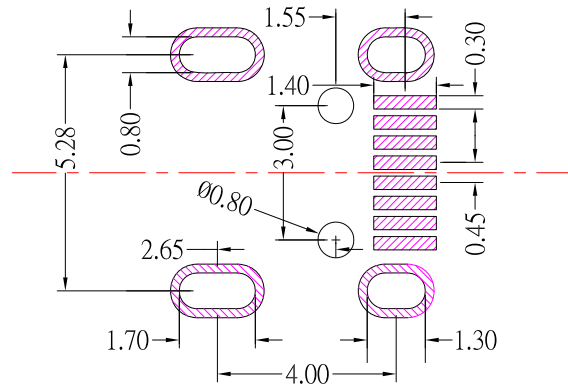
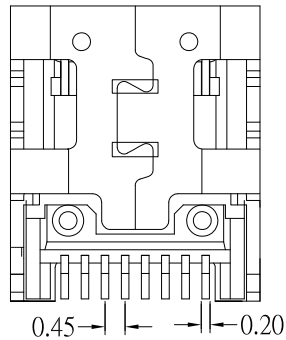


P.C.B LAYOUT MOUNTING PATTERN



SPECIFICATIONS

Electrical:

- 1.Current Rating: 1.0A / contact terminal
- 2.Voltage Rating: 30V DC
- 3.Contact Resistance: 50 milliohms Max
- 4.Dielectric Withstanding Voltage:
300 V AC AT Sec Level
- 5.Insulation Resistance: 1,000 MEGA ohms Min

Mechanical:

- 1.Connector Mate and Unmate Force
Mate force: 3.0 kgf (Max)
Unmate force: 0.7 kgf (Min)
- 2.Terminal Retention: 0.5 kgf (Min)

Material:

- 1.Housing:
High Temperature Thermal Plastics,
UL 94V-0 , LCP , Black
- 2.Contact: PHOSPHOR BRONZE
- 3.Shell: BRASS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls
Nickel under plated overall
- 2.Shell: Gold Plating

| | | | |
|----------|-------------|-------|--------|
| 4 | 更新鏡層 | Jack | 102813 |
| 3 | 更新為A0版 | Jack | 092413 |
| 2 | 新增外觀腳尺寸 | Jack | 080713 |
| 1 | 更新SPEC | Jack | 041113 |
| ITEM NO. | DESCRIPTION | DRAWN | DATE |



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TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD. ANGEL'S



UNITS MM

| | | | | |
|--------------|----------|-----------|----------|------------------------------|
| DRAWN BY: | DATE | MAT'L | TITLE | CONNECTOR |
| Jack Lu | 10/28/13 | | | |
| CHECKED BY: | DATE | FINISH | MODLE | MINI USB 8P/F DIP 4 腳長, 外殼鍍金 |
| Jacky Chen | 10/28/13 | | | |
| APPROVED BY: | DATE | SCALE | DWG NO. | MUSB-8B-D-G-S175 |
| Tony Kao | 10/28/13 | 1 : 1 | PART NO. | MUSB-8B-D-G-S175 |
| | | SHEET NO. | 1 of 1 | SIZE A4 |
| | | | | VER A1 |